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(54) **Fluororesin-coated quartz glass jig and method for producing the same**

(57) An object of the present invention is to provide a fluororesin-coated quartz glass jig free from peeling off of fluororesin coating on using hydrofluoric acid or from generating particles due to the etching of quartz glass, while yet preventing the generation of chipping by relaxing the impact imposed on the quartz glass by silicon wafers. It also is an object of the present invention to

provide a production method of the fluororesincoated quartz glass jig.

The object above is achieved by a fluororesin-coated quartz glass jig the surface thereof is wholly covered with a pinhole-free fluororesin coating, and by a method for producing the same.

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Description

Industrial Field of Application

[0001] The present invention relates to a quartz glass jig for use in cleaning silicon wafers, and in further detail, it relates to a quartz glass jig whose surface is wholly covered with a pinhole-free fluororesin coating and to a method for producing the same.

Prior Art

[0002] Naturally occurring quartz glass jigs have been used heretofore for cleaning silicon wafers. As exemplified by a carrier boat for silicon wafers, such quartz glass jigs are generally provided with mechanically processed grooves to mount thereon the wafers. Mechanical processing comprises shaving the quartz glass surface by using a cutting jig having vapor deposited thereon abrasives such as of diamond; however, since micro cracks generate by the machining, there has been such a problem as the contamination of wafers, because residual impurities remain trapped inside the micro cracks. Furthermore, such quartz glass jigs are generally used together with hydrofluoric acid solution. However, the hydrofluoric acid solution penetrates into the micro cracks as to roughen the surface irregularities of the quartz glass; this causes inconveniences such as the formation of flaws on the silicon wafers, the generation of particles due to chipping of protruded portions of the surface, or the generation of fluorosilicates, which form from quartz glass dissolved into the hydrofluoric acid solution and the adhesion of the generated fluorosilicates as foreign matters on the silicon wafer. Moreover, there happened a problem of causing chipping on the edge portion of the silicon wafer due to the abutment thereof against the groove portion of the quartz glass carrier boat, in case the silicon wafer was placed into or outside from the quartz glass carrier boat. In order to overcome the problems above, in Japanese Patent Laid-Open No. 89603/1995 is proposed to cover the quartz glass claws of the work support arm for transferring the works with a fluororesin. However, in case of cleaning the silicon wafers, hydrofluoric acid has been found to penetrate from the edge plane into the work support arm for transferring the works, and to cause peeling off of the fluororesin coating; or, contaminating substances have been found to elute out from the edge portion into the hydrofluoric acid solution to cause contamination of the silicon wafer. Another problem has been found concerning the work support arm for transferring the works; that is, cracks tended to generate in the fluororesin coating from the edges of the jigs to impair the adhesiveness of the coating on the quartz glass, and this caused separation of the fluororesin coating from the quartz glass in case the jigs were used for a long time.

Problems the Invention is to Solve

[0003] In the light of the aforementioned circumstances, the present inventors performed extensive studies on the quartz glass jigs for use in cleaning silicon wafers. As a result, they have found that, by forming a pinhole-free fluororesin on the entire surface of the quartz glass, the direct contact of the quartz glass with the hydrofluoric acid solution can be prevented from occurring. This avoided the peeling off of the fluororesin coating or the generation of particles attributed to the etching of the quartz glass, while relaxing the impact on the quartz glass imposed by silicon wafers, thereby preventing the generation of chipping. Additionally, it has been found that, by previously applying rounding working to the edges of the quartz glass jig or by further applying frost treatment to the surface of the quartz glass before forming the fluororesin coating above, the adhesiveness of the fluororesin coating to the surface of the quartz glass can be further improved in such a manner that the fluororesin coating can be prevented from being peeled off even in case the quartz glass jig is immersed in a hydrofluoric acid solution for a long duration of time. The present invention has been accomplished based on these findings.

[0004] More specifically, an object of the present invention is to provide a fluororesin-coated quartz glass jig, said jig being free from causing peeling off of the fluororesin coating due to the use of hydrofluoric acid or from generating particles ascribed to the etching of quartz glass, and yet, said jig being relaxed from the impact in case a silicon wafer is brought into contact therewith and thereby devoid of generating chipping.

[0005] A further object of the present invention is to provide a method for producing the fluororesin-coated quartz glass jig above.

Means for Solving the Problems

[0006] The objects above have been achieved by the present invention, and it provides a fluororesin-coated quartz glass jig characterized by that the surface thereof is wholly covered with a pinhole-free fluororesin-based resin coating, and a method for producing the same.

[0007] The fluororesin-coated quartz glass jigs according to the present invention refers to wafer carrier boats, chucks, etc., that are used in cleaning silicon wafers, and these jigs are characterized by having a surface wholly covered with a pinhole-free fluororesin coating. Usable as the fluororesins above are those having excellent heat resistance, chemical resistance, corrosion resistance, wear resistance, etc., and specifically mentioned is at least one resin selected from tetrafluoroethylene resin, tetrafluoroethylene-perfluoroalkyl vinyl ether resin, perfluoroethylene-propylene resin, ethylene-tetrafluoroethylene resin, chlorotrifluoroethylene resin, ethylene-chlorotrifluoroethylene resin, vinylidene difluoride resin, vinyl fluoride resin, and tetrafluoroeth-

ylene-perfluorodioxol resin. Particularly preferred among them is tetrafluoroethylene resin, because it has superior heat resistance, chemical resistance, corrosion resistance, and wear resistance. The fluoro-resin is dissolved in a solvent to prepare a fluoro-resin coating agent, and the resulting agent is applied to provide a coating having a dry thickness of 50 μm or thicker. If the thickness of the coating should be less than the thickness range specified above, not only the pinholes tend to generate in the coating as to allow the hydrofluoric acid solution to penetrate to the quartz glass to cause corrosion, but also the coating becomes extremely thin at the edge portions as to easily generate cracks. Hence, such a case is not preferred. The fluoro-resin coating can be formed by spraying the fluoro-resin coating agent or by applying the same employing the electrodeposition painting method. At any rate, the fluoro-resin coating agent is applied in a plurality of times to provide a pinhole-free coating until the required film thickness is achieved. Further preferred is to bake the coating. In particular, the edges are subjected to rounding to provide curved portions each having a curvature (r) of 0.5 mm or larger, such that the coating with sufficient thickness can be formed at the edges. The rounding can be carried out by a method comprising heating the edges with an oxyhydrogen flame, or by mechanically grinding the edges using a grinder and the like. As the solvent for use in dissolving therein the fluoro-resin, there can be mentioned an alkylene glycol such as propylene glycol, etc.; an ester such as methyl ethyl acetate, methyl butyl acetate, etc.; a ketone such as acetone, methyl isobutyl ketone, etc.; an alcohol such as ethylene alcohol, butyl alcohol, etc.; toluene, xylene, etc.

[0008] In order to further improve the adhesiveness of the fluoro-resin coating to quartz glass, preferred is to apply the fluoro-resin solution after subjecting the quartz glass surface to frost treatment. By applying frost treatment, irregularities are formed on the surface of the quartz glass, and the anchoring effect provided by those irregularities decreases the peeling off of the film by improving the adhesiveness of the fluoro-resin coating. As the frost treatment, there can be mentioned a method comprising blowing a crystalline silicon dioxide powder or SiC powder onto the surface of the quartz glass surface, or a method comprising forming irregularities on the surface of the quartz glass by using a chemical solution. Particularly preferred is a frost treatment using a chemical solution, because it can be performed without impairing the mechanical strength of the quartz glass and yet, free from generating micro cracks. As the chemical solution, there can be mentioned a solution containing hydrogen fluoride and ammonium fluoride, or a solution additionally containing acetic acid as described in Japanese Patent Laid-Open No. 267679/1995 or Japanese Patent Laid-Open No. 36140/1998. Frost treatment can be performed without any particular limitation concerning the surface rough-

ness, but preferred is that the surface roughness value R_a falls within a range of from 1 to 10 μm , and that the value for R_{max} should fall within a range of from 5 to 50 μm .

Mode for Practicing the Invention

[0009] Examples for practicing the present invention are described below, but it should be understood that the present invention is not limited thereby.

Examples

Example 1

[0010] A 6-inch size quartz glass carrier boat (having provided with 4 groove bars) was prepared, and was subjected to rounding by blasting the surface thereof with crystalline silicon dioxide powder to obtain a boat with edges having an r -value of 2 mm. Subsequently, the entire quartz glass carrier boat was blasted with crystalline silicon dioxide powder 100 to 300 μm in particle size to thereby form irregularities having a surface roughness R_a of 2.5 μm and R_{max} of 20 μm . The surface of the resulting quartz glass boat was further coated with a tetrafluoroethylene resin at a dry thickness of 400 μm by means of electrostatic coating. Then, 25 pieces of 6-inch silicon wafers were mounted on the thus obtained fluoro-resin-coated quartz glass carrier boat to perform a so-called RCA cleaning (combination cleaning with $\text{HCl} + \text{H}_2\text{O}_2$ or $\text{H}_2\text{SO}_4 + \text{H}_2\text{O}_2$ or $\text{NH}_4\text{OH} + \text{H}_2\text{O}_2$), and were subjected to hydrofluoric acid pickling, rinsing with pure water, and to final drying using isopropylalcohol drier (IPA drier). The particles remaining on the surface of the silicon wafer were counted by using a laser particle counter to find only about 50 particles residing on the peripheral portion of the silicon wafer.

Example 2

[0011] A 6-inch size quartz glass carrier boat (having provided with 4 groove bars) similar to that used in Example 1 was prepared, and was subjected to rounding to a r -value of 1 mm by applying oxyhydrogen flame heating to the edges. Subsequently, the quartz glass carrier boat was immersed into a chemical solution containing hydrofluoric acid and ammonium fluoride to form surface irregularities with R_a of 1.5 μm and R_{max} of 13 μm . Then, tetrafluoroethylene resin was applied to the surface of the quartz glass carrier boat by means of electrostatic coating to obtain a film with a dry thickness of 200 μm . Then, 25 pieces of 6-inch silicon wafers were mounted on the thus obtained fluoro-resin-coated quartz glass carrier boat to perform the above mentioned RCA cleaning, and were subjected to hydrofluoric acid pickling, rinsing with pure water, and to final drying using an IPA drier. The particles remaining on the surface of the silicon wafer were counted by using a laser particle

counter in a manner similar to that described in Example 1, but only about 20 particles were found residing on the peripheral portion of the silicon wafer.

Comparative Example 1

[0012] A 6-inch size quartz glass carrier boat similar to that used in Example 1 was prepared, and was used in the cleaning of silicon wafers in a manner similar to that described in Example 1, except for forming the fluororesin coating. As a result, 700 particles were counted on the surface of the silicon wafer. The particles were found to generate on the central portion of the silicon wafer, and the production yield of the silicon wafer was decreased.

Comparative Example 2

[0013] A 6-inch size quartz glass carrier boat similar to that used in Example 1 was prepared, and the edges of the groove portions were heated by oxyhydrogen flame to perform rounding to an r-value of 1 mm. Then, the resulting quartz glass carrier boat was blasted with crystalline silicon dioxide powder of 100 to 300 μm in particle size to thereby form irregularities having a surface roughness Ra of 2.5 μm and Rmax of 20 μm . Subsequently, by means of electrostatic coating, tetrafluoroethylene resin coating of 400 μm in thickness was formed only on the surface of the groove portions of the resulting quartz glass boat. Cleaning of silicon wafers was performed in a manner similar to that described in Example 1 to observe about 20 particles remaining on the peripheral portions of the silicon wafers. However, with repeated cleaning, the hydrofluoric acid solution was found to penetrate from the edge portion of the fluororesin coating as to cause peeling off of the fluororesin coating on carrying out the tenth cleaning.

Effect of the Invention

[0014] The fluororesin-coated quartz glass jig according to the present invention is wholly covered with a pinhole-free fluororesin coating, and it enables cleaning treatment of silicon wafers without causing peeling off of the coating or contaminating silicon wafers with particles and the like. Hence, the present invention is of high industrial value in that it realizes the production of silicon wafers at high yield.

Claims

1. A fluororesin-coated quartz glass jig characterized by that the surface thereof is wholly covered with a pinhole-free fluororesin coating.
2. A fluororesin-coated quartz glass jig as claimed in Claim 1, wherein the fluororesin is at least one resin

selected from tetrafluoroethylene resin, tetrafluoroethylene-perfluoroalkyl vinyl ether resin, perfluoroethylene-propylene resin, ethylene-tetrafluoroethylene resin, chlorotrifluoroethylene resin, ethylene-chlorotrifluoroethylene resin, vinylidene difluoride resin, vinyl fluoride resin, and tetrafluoroethylene-perfluorodioxol resin.

3. A fluororesin-coated quartz glass jig as claimed in Claim 1, wherein the thickness of the fluororesin coating is 50 μm or more.
4. A method for producing a fluororesin-coated quartz glass jig, comprising rounding all the edges of a quartz glass jig into curved portions each having a curvature (r) of 0.5 mm or larger, and forming a fluororesin coating on the entire quartz glass jig by treating the resulting jig with a fluororesin coating agent.
5. A method for producing a fluororesin-coated quartz glass jig, comprising applying a frost treatment to a quartz glass jig, and forming a fluororesin coating on the entire quartz glass jig by treating the resulting jig with a fluororesin coating agent.
6. A method for producing a fluororesin-coated quartz glass jig as claimed in Claim 5, wherein the frost treatment is a surface treatment using a chemical agent.
7. A method for producing a fluororesin-coated quartz glass jig as claimed in Claim 5 or 6, wherein all the edges of the quartz glass jig are subjected to rounding to a curvature (r) value of 0.5 mm or larger before the frost treatment.



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EUROPEAN SEARCH REPORT

Application Number
EP 01 12 8581

DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.7)
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Place of search THE HAGUE		Date of completion of the search 4 March 2002	Examiner Van Bommel, L
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**ANNEX TO THE EUROPEAN SEARCH REPORT
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This annex lists the patent family members relating to the patent documents cited in the above-mentioned European search report. The members are as contained in the European Patent Office EDP file on
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